AUTOMOTIVE

RoHS

COMPLIANT

HALOGEN

FREE



Vishay General Semiconductor

Surface Mount Trench MOS Barrier Schottky Rectifiers

TMBS® eSMP® Series



Cathode O Anode

DESIGN SUPPORT TOOLS

click logo to get started



| PRIMARY CHARACTERISTICS | | | |
|--|----------------|--|--|
| I _{F(AV)} | 1.0 A | | |
| V _{RRM} | 60 V | | |
| I _{FSM} | 30 A | | |
| V _F at I _F = 1 A (T _A = 125 °C) | 0.45 V | | |
| T _J max. | 150 °C | | |
| Package | SMF (DO-219AB) | | |
| Circuit configuration | Single | | |

FEATURES

- Trench MOS Schottky technology
- · Low profile package
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | |
|--|-------------------------------|-------------|------|
| PARAMETER | SYMBOL | V1F6 | UNIT |
| Device marking code | | V16 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 60 | V |
| Maximum average forward rectified current (fig.1) | I _{F(AV)} (1) | 1.0 | А |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 30 | А |
| Operating junction temperature range | T _J ⁽²⁾ | -40 to +150 | °C |
| Storage temperature range | T _{STG} | -55 to +150 | |

Notes

- (1) Free air, mounted on FR4 PCB, 2 oz. standard footprint
- $^{(2)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta,JA}$



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|------------------------|--------------------------|-----------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | I _F = 0.5 A | - T _A = 25 °C | | 0.45 | - | V |
| | I _F = 1.0 A | | V _F ⁽¹⁾ | 0.52 | 0.60 | |
| | I _F = 0.5 A | T _A = 125 °C | VF(') | 0.36 | - | |
| | I _F = 1.0 A | | | 0.45 | 0.53 | |
| Reverse current | V 60.V | T _A = 25 °C | Γ _A = 25 °C | - | 0.27 | - mA |
| | V _R = 60 V | T _A = 125 °C | - I _R ⁽²⁾ - | 1.0 | 5 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 135 | - | pF |

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted) | | | | |
|---|-------------------------|------|-------|--|
| PARAMETER | SYMBOL | V1F6 | UNIT | |
| Typical thermal resistance | R _{θJA} (1)(2) | 125 | °C/W | |
| | R _{0JM} (2) | 27 | - C/W | |

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Device mounted on FR4 PCB, 2 oz. standard footprint, thermal resistance $R_{\theta JA}$ – junction-to-ambient; thermal resistance $R_{\theta JM}$ – junction-to-mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V1F6-M3/H | 0.015 | Н | 3000 | 7" diameter plastic tape and reel |
| V1F6-M3/I | 0.015 | I | 10 000 | 13" diameter plastic tape and reel |
| V1F6HM3/H (1) | 0.015 | Н | 3000 | 7" diameter plastic tape and reel |
| V1F6HM3/I (1) | 0.015 | I | 10 000 | 13" diameter plastic tape and reel |

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

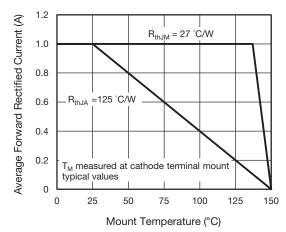


Fig. 1 - Maximum Forward Current Derating Curve

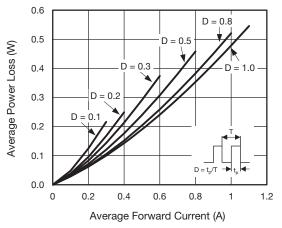


Fig. 2 - Average Power Loss Characteristics

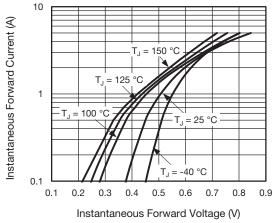


Fig. 3 - Typical Instantaneous Forward Characteristics

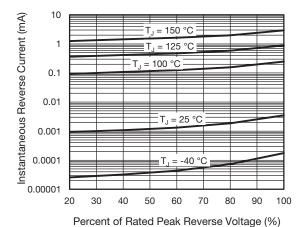


Fig. 4 - Typical Reverse Leakage Characteristics

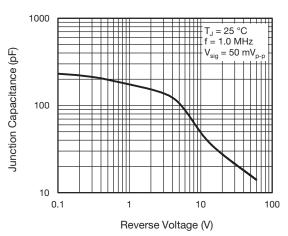


Fig. 5 - Typical Junction Capacitance

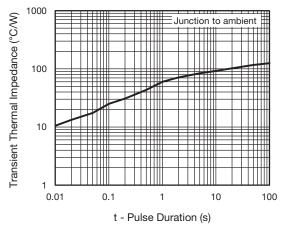
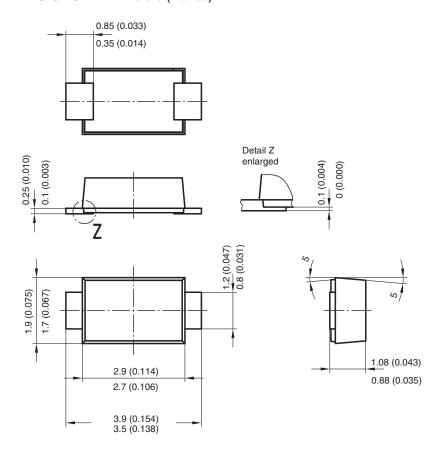


Fig. 6 - Typical Transient Thermal Impedance

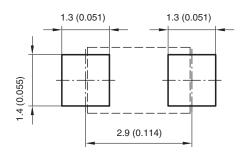


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PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



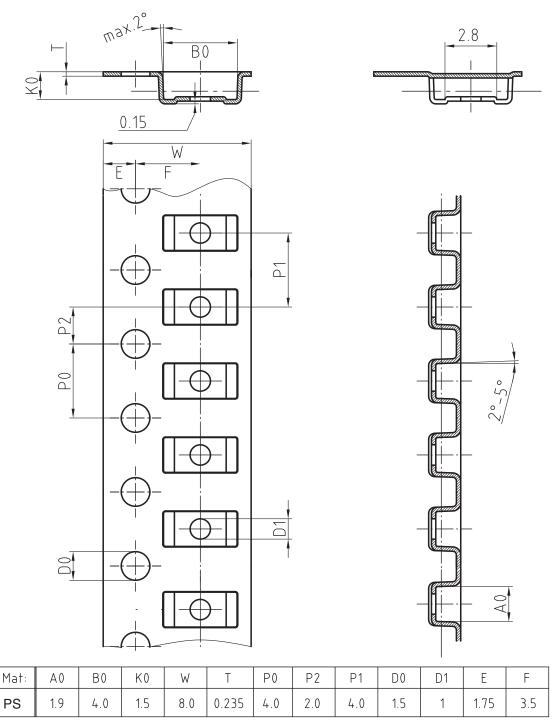
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BLISTERTAPE DIMENSIONS in millimeters: **SMF (DO-219AB)**



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